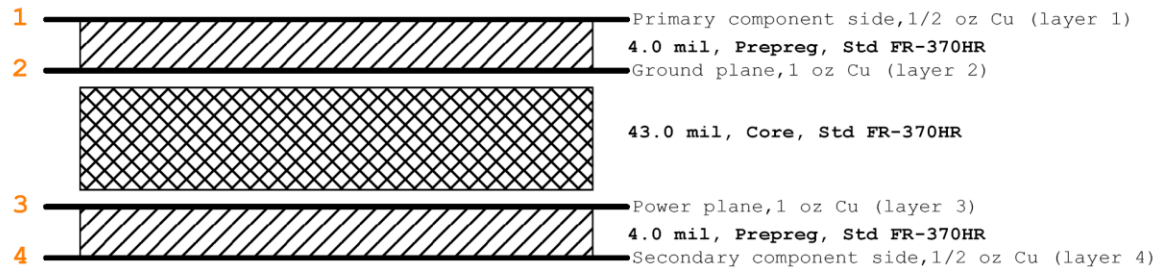


LAYOUT NOTES:

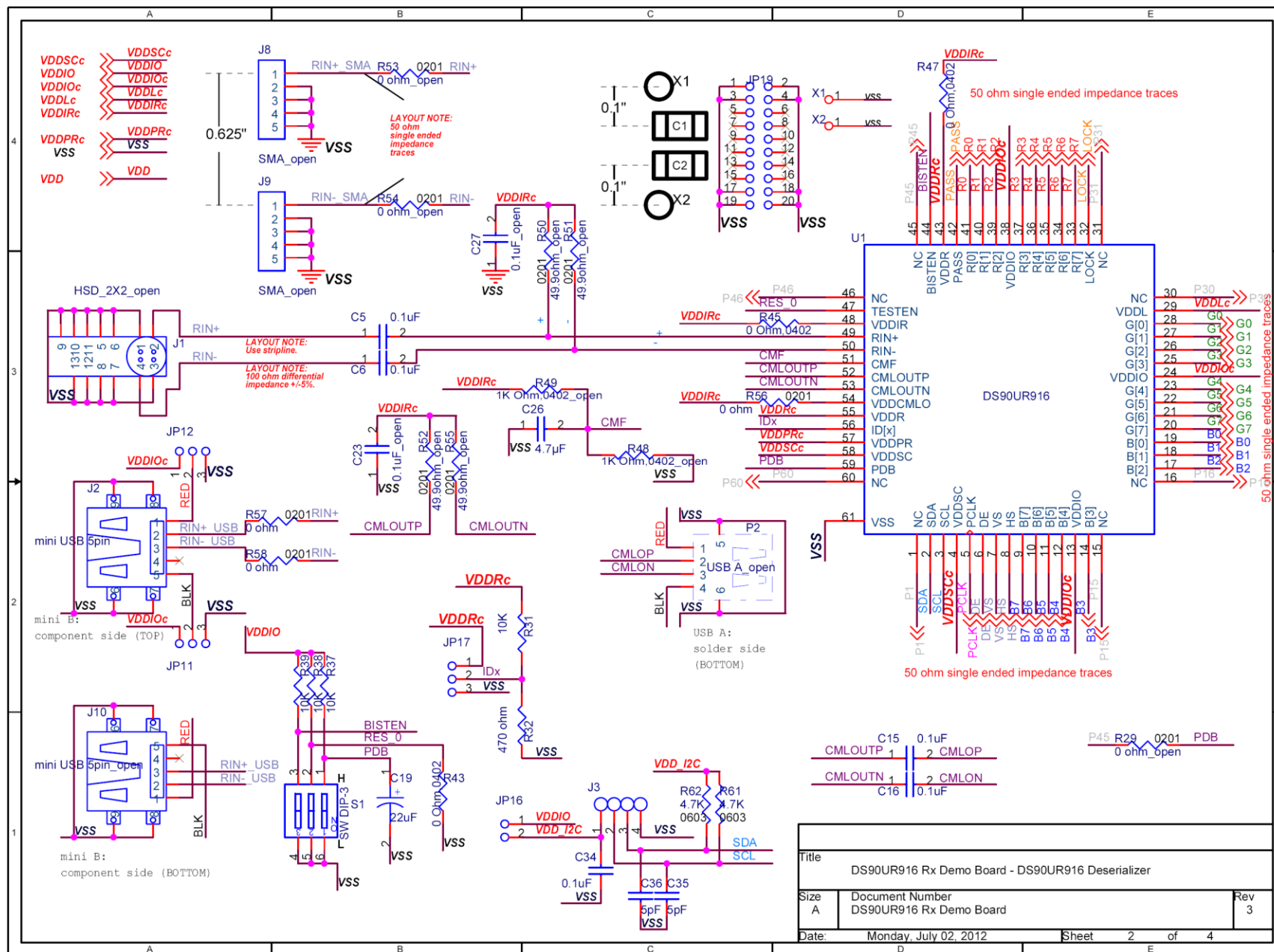
- 1) 4 layer board.
- 2) Use standard FR-406 or FR-370HR.
- 3) 5% impedance tolerance.
- 4) Minimum 4 standoffs on each corner of board. (0.156 X 4).

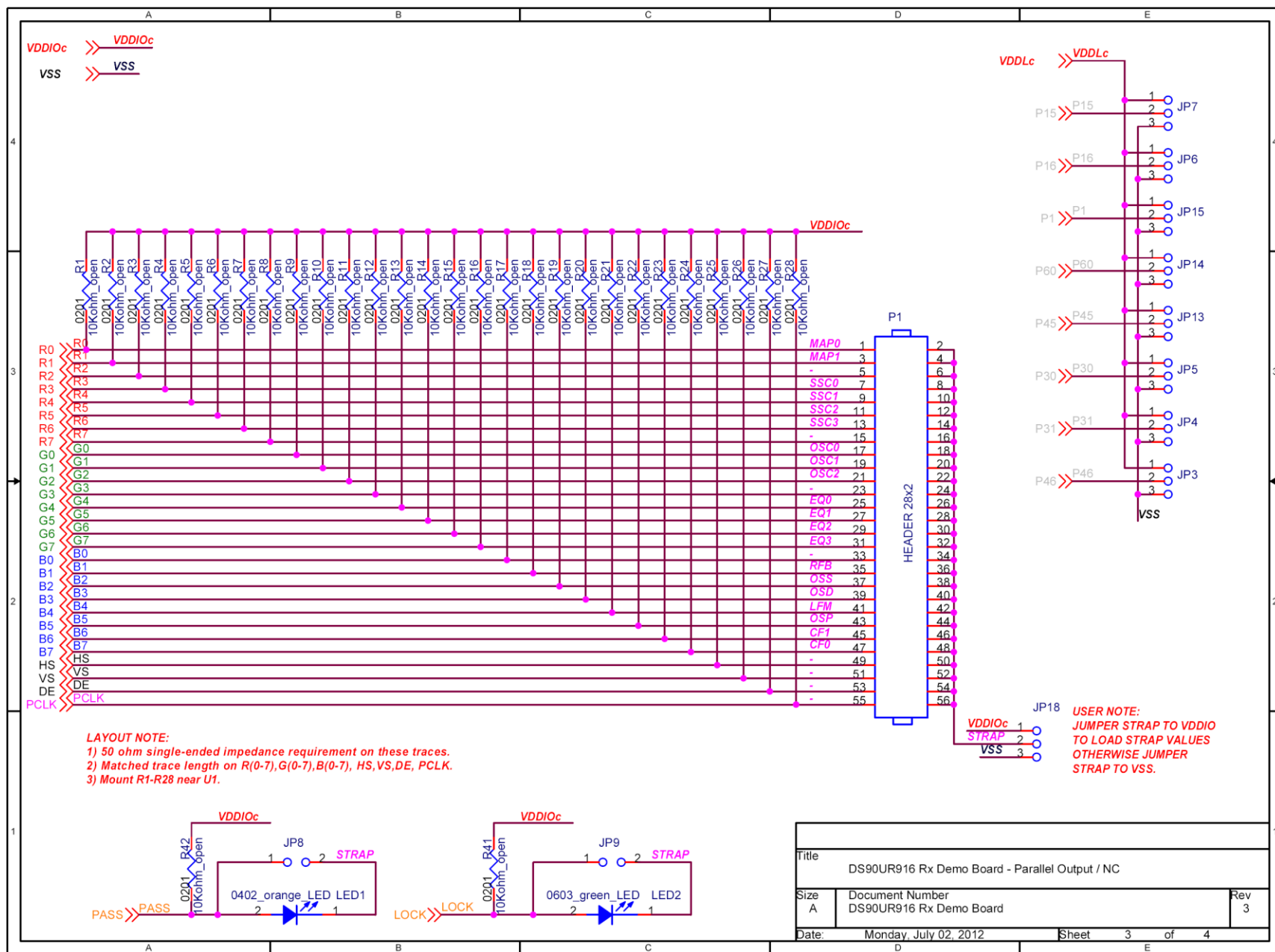


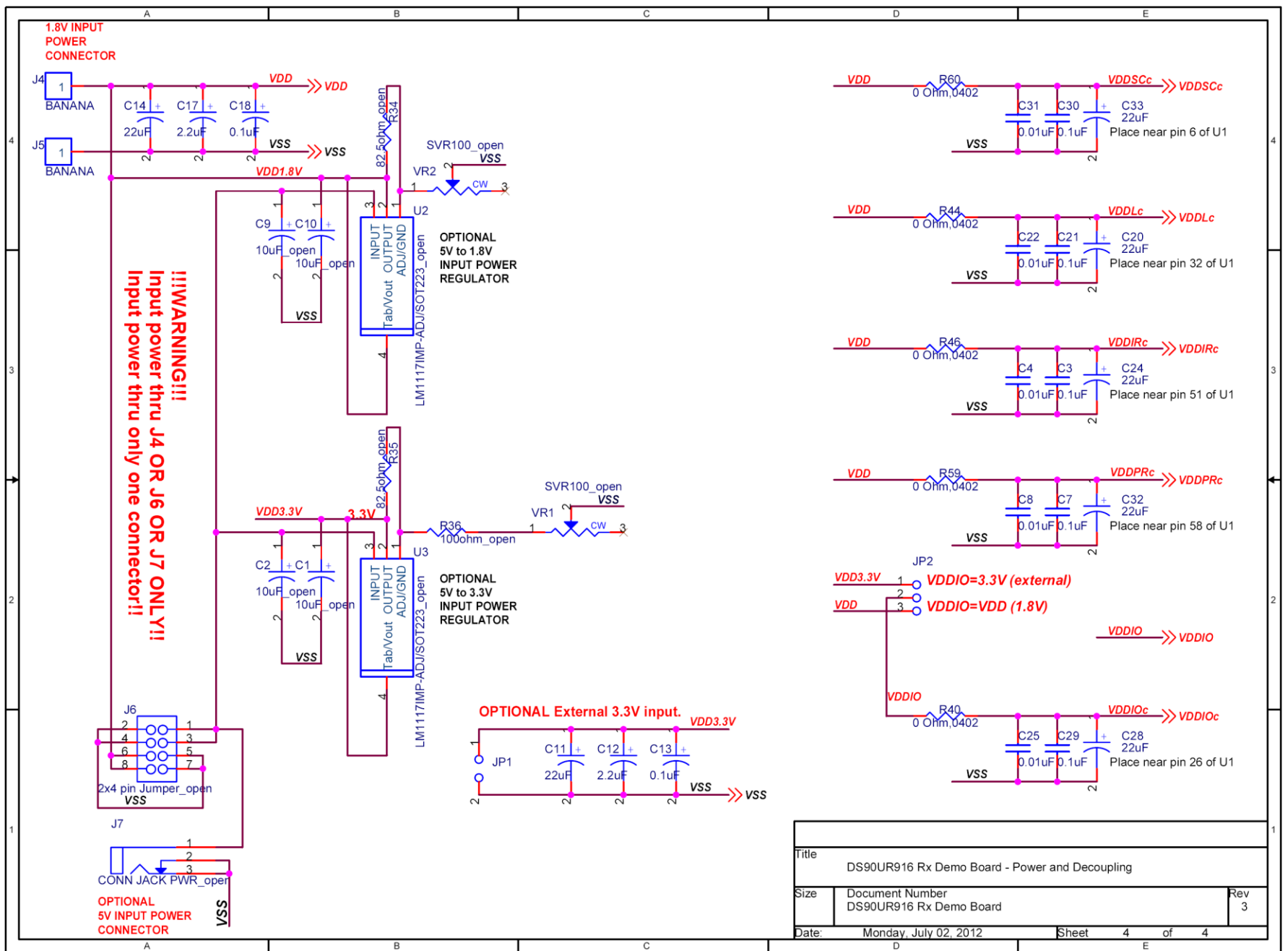
 Core Material

 Prepreg Material

Title		
DS90UR916 Rx Demo Board - Board Stackup		
Size	Document Number	Rev
A	DS90UR916 Rx Demo Board	3
Date: Monday, July 02, 2012		Sheet 1 of 4







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